

6N135/6N136

■ Features

1. High speed response t_{PHL} , t_{PLH}
 (6N135 : MAX. $1.5\ \mu s$ at $R_L = 4.1k\ \Omega$)
 (6N136 : MAX. $0.8\ \mu s$ at $R_L = 1.9k\ \Omega$)
2. High common mode rejection voltage
 (CM_H : TYP. $1kV/\ \mu s$)
3. Standard dual-in-line package
4. Recognized by UL, file No. E64380

■ Applications

1. Computers, measuring instruments, control equipment
2. High speed line receivers, high speed logic
3. Telephone sets
4. Signal transmission between circuits of different potentials and impedances

■ Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	25	mA
	*1 Peak forward current	I _F	50	mA
	*2 Peak transient forward current	I _{FM}	1	A
	Reverse voltage	V _R	5	V
	Power dissipation	P	45	mW
Output	Supply voltage	V _{CC}	-0.5 to +15	V
	Output voltage	V _O	-0.5 to +15	V
	Emitter-base reverse withstand voltage (Pin 5 to 7)	V _{EBO}	5	V
	Average output current	I _O	8	mA
	Peak output current	I _{OP}	16	mA
	Base current (Pin 7)	I _B	5	mA
	Power dissipation	P _O	100	mW
*3 Isolation voltage				
*4 Soldering temperature				

*1 50% duty cycle, Pulse width=1ms

Decreases at the rate of $1.6mA/^\circ C$ if the external temperature is $70^\circ C$ or more.

*2 Pulse width $\leq 1\ \mu s$, 300P/S

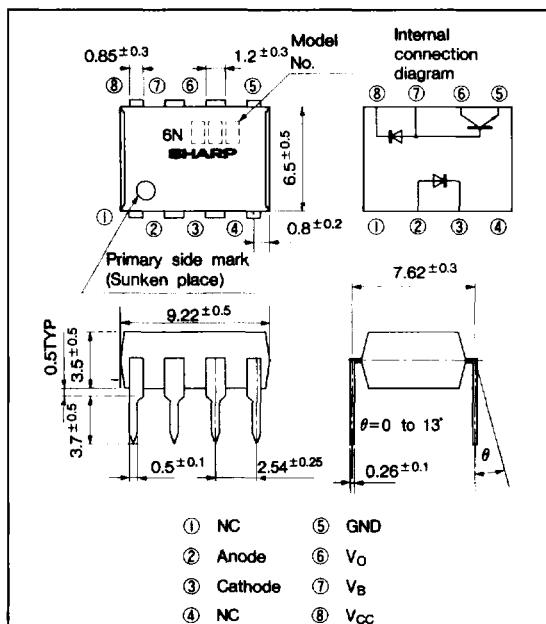
*3 40 to 60% RH, AC for 1 minute

*4 For 10 seconds

General Purpose Type Photocoupler

■ Outline Dimensions

(Unit : mm)



* "OPIC" (Optical IC) is a trademark of the SHARP Corporation. An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that occur in equipment using any of SHARP's devices, shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest version of the device specification sheets before using any SHARP's device.

■ Electro-optical Characteristics (Ta=0 to +70°C unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*5 Current transfer ratio	6N135 CTR(1)	T _a =25°C, I _F =16mA	7.0	40	—	%
	6N136 CTR(1)	V _O =0.4V, V _{CC} =4.5V	19	40	—	%
	6N135 CTR(2)	I _F =16mA, V _O =0.5V	5.0	43	—	%
	6N136 CTR(2)	V _{CC} =4.5V	15	43	—	%
Logic (0) output voltage	V _{OL}	*7 I _F =16mA, V _{CC} =4.5V	—	0.1	0.4	V
Logic (1) output current	I _{OH} (1)	T _a =25°C, I _F =0 V _{CC} =V _O =5.5V	—	3.0	500	nA
	I _{OH} (2)	T _a =25°C, I _F =0 V _{CC} =V _O =15V	—	0.01	1.0	μA
	I _{OH} (3)	I _F =0, V _{CC} =V _O =15V	—	—	50	μA
Logic (0) supply current	I _{CCL}	I _F =16mA, V _{CC} =15V V _O =open	—	200	—	μA
Logic (1) supply current	I _{CCH} (1)	T _a =25°C, V _{CC} =15V V _O =open, I _F =0	—	0.02	1.0	μA
	I _{CCH} (2)	V _{CC} =15V V _O =open, I _F =0	—	—	2.0	μA
Input forward voltage	V _F	T _a =25°C, I _F =16mA	—	1.7	1.95	V
Input forward voltage temperature coefficient	ΔV _F /ΔT _a	I _F =16mA	—	-1.9	—	mV/°C
Input reverse voltage	BV _R	T _a =25°C, I _R =10 μA	5.0	—	—	V
Input capacitance	C _{IN}	V _F =0, f=1MHz	—	60	—	pF
*6 Leak current (input-output)	I _{IO}	T _a =25°C, 45%RH, t=5s V _{IO} =3kVDC	—	—	1.0	μA
*6 Isolation resistance (input-output)	R _{IO}	V _{IO} =500VDC	—	10 ¹²	—	Ω
*6 Capacitance (input-output)	C _{IO}	f=1MHz	—	0.6	—	pF
Transistor current amplification factor	h _{FE}	V _O =5V, I _O =3mA	—	70	—	

*5 Current transfer ratio is the ratio of input current and output current expressed in %.

Note) Typical value : at Ta=25°C

*6 Measured as 2-pin element (Short 1, 2, 3, 4 and 5, 6, 7, 8)

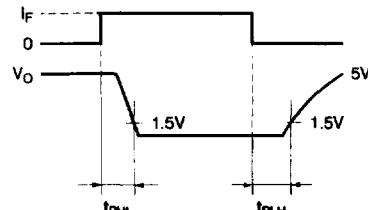
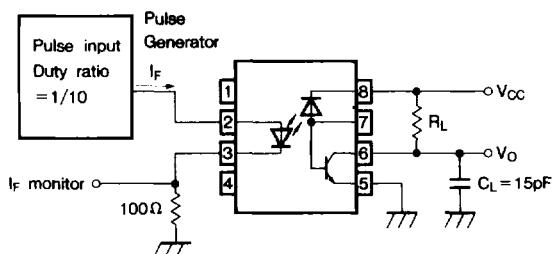
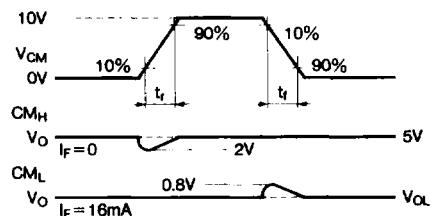
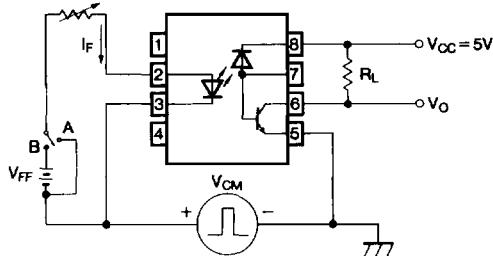
*7 6N135 : I_O=1.1mA, 6N136 : I_O=2.4mA

■ Switching Characteristics(Ta = 25°C, V_{CC} = 5V, I_F = 16mA)

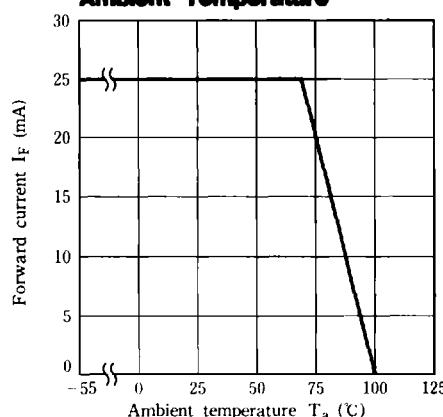
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*8 Propagation delay time Output (1) → (0)	t _{PHL}	R _L = 4.1kΩ	—	0.3	1.5	μs
*8 Propagation delay time Output (0) → (1)	t _{PLH}	R _L = 1.9kΩ	—	0.3	0.8	μs
*9 Propagation delay time Output (1) → (0)	t _{PHL}	R _L = 4.1kΩ	—	0.4	1.5	μs
*9 Propagation delay time Output (0) → (1)	t _{PLH}	R _L = 1.9kΩ	—	0.3	0.8	μs
*10,11 Instantaneous common mode rejection voltage "output (1)"	C _{MH}	*12 I _F = 0, V _{CM} = 10V _{P-P}	—	1 000	—	V/μs
*10,11 Instantaneous common mode rejection voltage "output (0)"	C _{ML}	*12 V _{CM} = 10V _{P-P} , I _F = 16mA	—	-1 000	—	V/μs
*13 Bandwidth	BW	R _L = 100Ω	—	2.0	—	MHz

*8 R_L = 4.1kΩ is equivalent to one LSTTL and 6.1kΩ pull-up resistor.*10 Instantaneous common mode rejection voltage "output (1)" represents a common mode voltage variation that can hold the output above (1) level (V_O > 2.0V).Instantaneous common mode rejection voltage "output (0)" represents a common mode voltage variation that can hold the output above (0) level (V_O < 0.8V).*12 6N135 : R_L = 4.1kΩ 6N136 : R_L = 1.9kΩ

*13 Bandwidth represents a point where AC input goes down by 3dB.

9 Test Circuit for Propagation Delay Time**11 Test Circuit for Instantaneous Common Mode Rejection Voltage**

**Fig. 1 Forward Current vs.
Ambient Temperature**



**Fig. 3 Forward Current vs.
Forward Voltage**

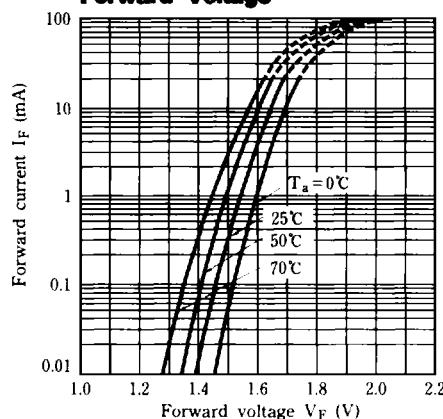
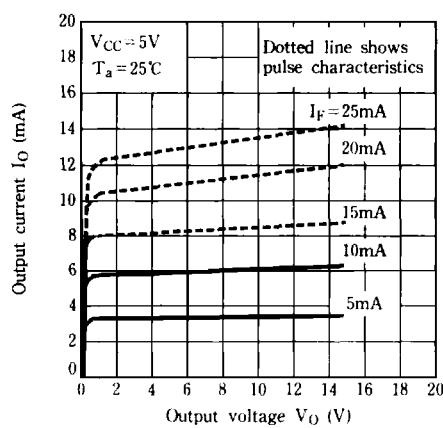
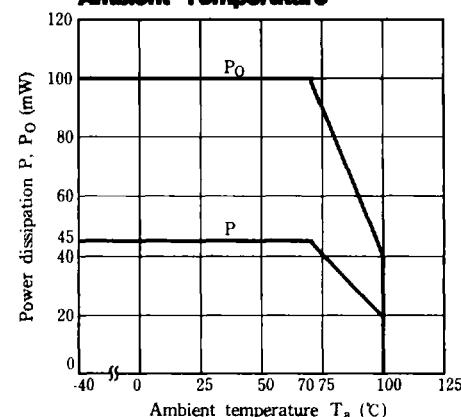


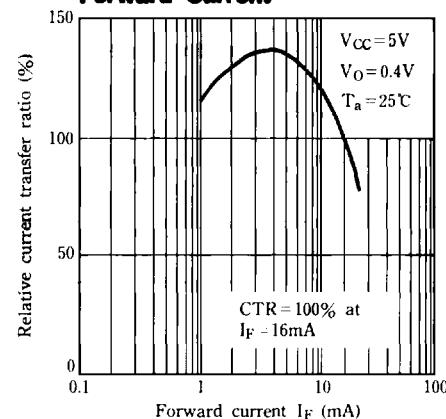
Fig. 5 Output Current vs. Output Voltage



**Fig. 2 Power Dissipation vs.
Ambient Temperature**



**Fig. 4 Relative Current Transfer Ratio vs.
Forward Current**



**Fig. 6 Relative Current Transfer Ratio vs.
Ambient Temperature**

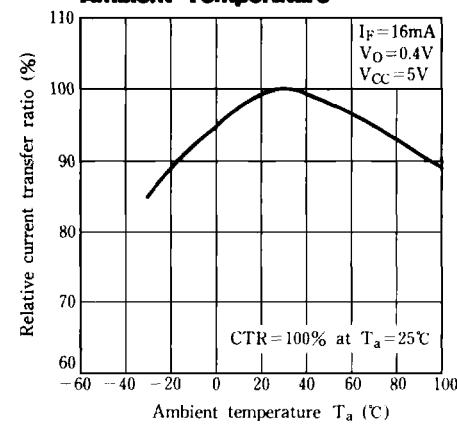


Fig. 7 Propagation Delay Time vs. Ambient Temperature

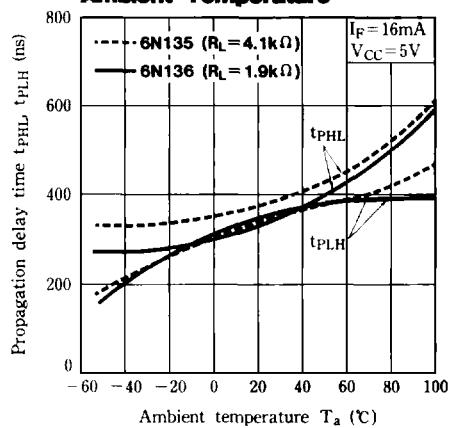


Fig. 8 High Level Output Current vs. Ambient Temperature

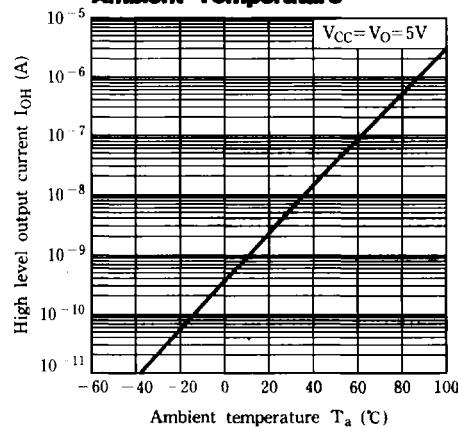
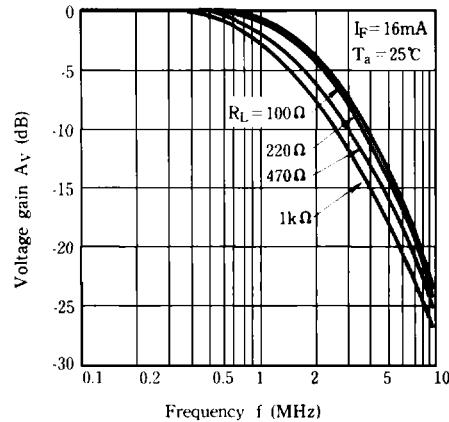
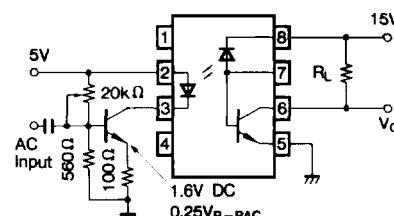


Fig. 9 Frequency Response



Test Circuit for Frequency Characteristic



■ Precautions for Use

- (1) It is recommended that a by-pass capacitor of more than $0.01 \mu F$ be added between V_{CC} and GND near the device in order to stabilize power supply line.
- (2) Transistor of detector side in bipolar configuration is apt to be affected by static electricity for its minute design. When handling them, general counterplan against static electricity should be taken to avoid breakdown of devices or degradation of characteristics.
- As for other general cautions, please refer to the chapter "Precautions for Use". (Page 78 to 93)